

## Product Summary

<b>V<sub>BR</sub> min</b>	<b>I<sub>pp</sub> max</b>	<b>C<sub>IN</sub> typ</b>
14.5V	25A	160pF

## Description

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in portable applications such as cellular phones, digital cameras and MP3 players.

## Applications

- Cellular Handsets
- Portable Electronics
- Computers and Peripheral

## Features

- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±30kV, Contact ±30kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

## Mechanical Data

- Case: SOD323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead-free Plating). Solderable per MIL-STD-202, Method 208e3
- Weight: 0.004 grams (Approximate)

SOD323



Top View



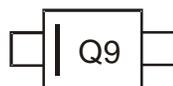
Device Schematic

## Ordering Information (Note 4)

Product	Compliance	Marking	Reel size(inches)	Tape width(mm)	Quantity per reel
D14V0H1U2WS-7	Standard	Q9	7	8	3,000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

## Marking Information



Q9 = Product Type Marking Code  
Line Denotes Pin 1

### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P <sub>PP</sub>	600	W	8/20μs, Per Figure 3
Peak Pulse Current	I <sub>PP</sub>	25	A	8/20μs, Per Figure 3
ESD Protection – Contact Discharge	V <sub>ESD_Contact</sub>	±30	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V <sub>ESD_Air</sub>	±30	kV	Standard IEC 61000-4-2
ESD Protection – Human Body Model	V <sub>ESD_HBM</sub>	±16	kV	Standard IEC 61000-4-2

### Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P <sub>D</sub>	200	mW
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>θJA</sub>	625	°C/W
Operating Temperature Range	T <sub>J</sub>	-55 to +125	°C
Storage Temperature Range	T <sub>STG</sub>	-65 to +150	°C

### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Working Voltage	V <sub>RWM</sub>	—	—	14	V	—
Reverse Current (Note 6)	I <sub>R</sub>	—	10	100	nA	V <sub>R</sub> = V <sub>RWM</sub> = 14V
Reverse Breakdown Voltage	V <sub>BR</sub>	14.5	—	17.5	V	I <sub>R</sub> = 1mA
Reverse Clamping Voltage	V <sub>CL</sub>	—	—	20	V	I <sub>PP</sub> = 5A, t <sub>p</sub> = 8/20μs
		—	—	23		I <sub>PP</sub> = 15A, t <sub>p</sub> = 8/20μs
		—	—	25		I <sub>PP</sub> = 25A, t <sub>p</sub> = 8/20μs
Capacitance	C <sub>T</sub>	—	160	—	pF	V <sub>R</sub> = 0V, f = 1MHz

Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at <http://www.diodes.com>.  
6. Short duration pulse test used to minimize self-heating effect.

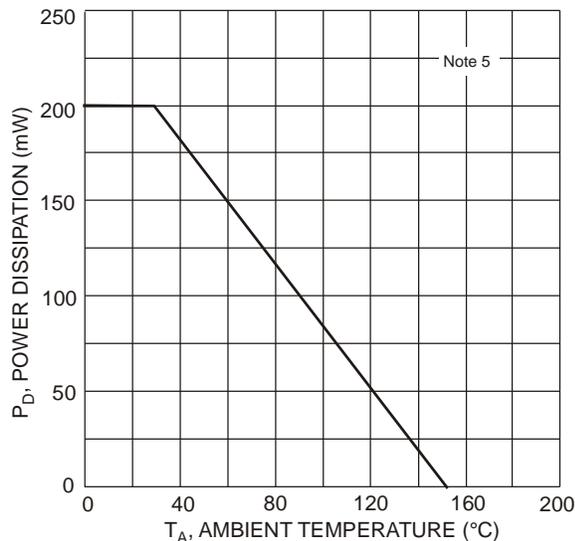


Figure 1 Power Derating Curve

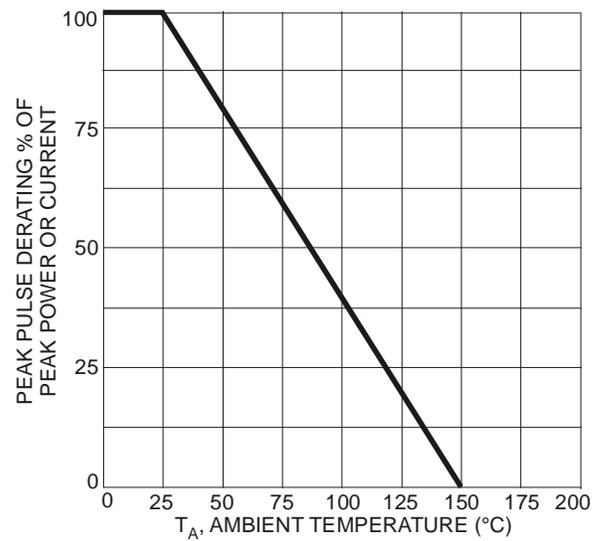


Figure 2 Pulse Derating Curve

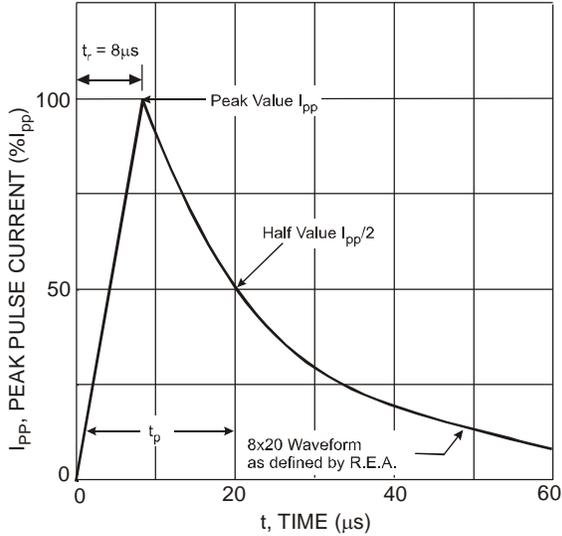


Figure 3 Typical 8 x 20µs Pulse Waveform

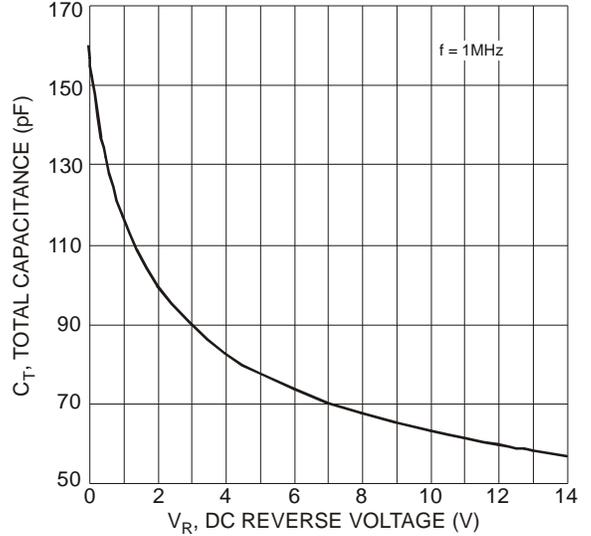


Figure 4 Typical Total Capacitance

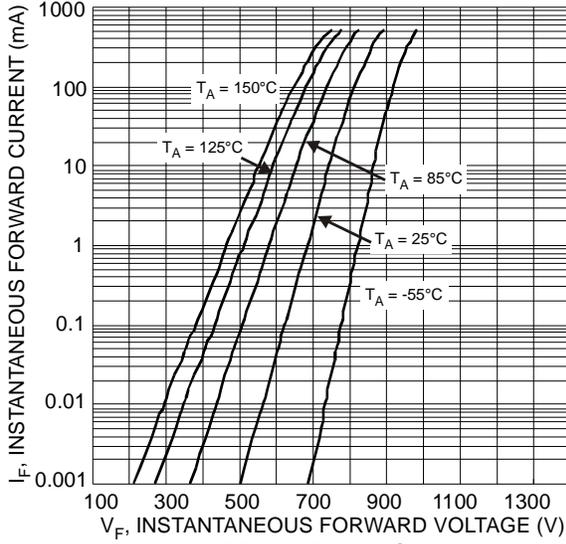


Figure 5 Typical Forward Characteristics

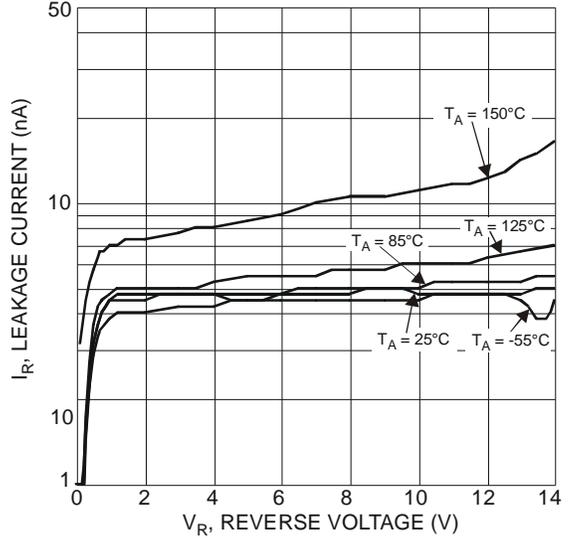
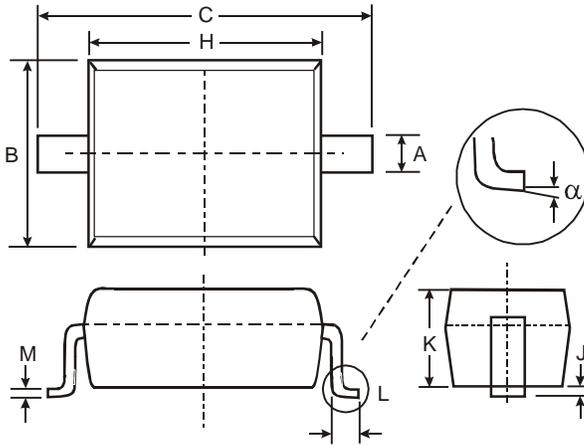


Figure 6 Typical Reverse Characteristics

**Package Outline Dimensions**

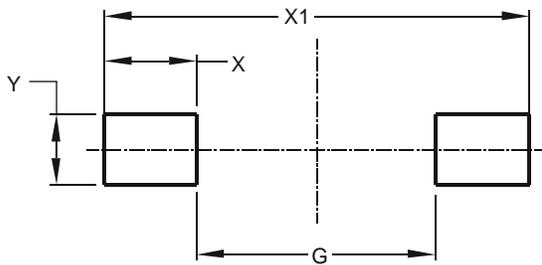
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



SOD323		
Dim	Min	Max
A	0.25	0.35
B	1.20	1.40
C	2.30	2.70
H	1.60	1.80
J	0.00	0.10
K	1.0	1.1
L	0.20	0.40
M	0.10	0.15
$\alpha$	0°	8°
<b>All Dimensions in mm</b>		

**Suggested Pad Layout**

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
G	1.520
X	0.590
X1	2.700
Y	0.450

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